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I hereby state that I any amendment ref	P97/0 have revierred to a	ewed and u bove.	nd was amended on nderstand the contents	United States Applications of the above-identified s	(if appli pecification, includi	icable). ng the claims, a	
I hereby claim fore certificate, or § 3656 and have also ident	ign priori (a) of any l tified belo	ty benefits PCT Intern w, by checl	under 35 U.S.C. § 11: ational application whi sing the box, any fore	rial to the patentability and an indicate of an ich designated at least or graphication for patent which priority is claime	y foreign application ne country other that t or inventor's certi	n(s) for patent n United States	. listed below
Prior Foreign Appli	cation(s)					Priority Not	Claimed
P. Hei. 8-2	28713	_	Japan	·			
(Number)			(Country)	(Day/Month/Y	ear Filed)		
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(Number)			(Country)	(Day/Month/Y	ear Filed)		
I hereby claim the b	enefits un	der 35 U.S.	.C. § 119(e) of any Un	ited States provisional ap	oplication(s) listed b	elow.	
(Application Number)			(Filin	g Date)			
prior United States duty to disclose info	ted States or PCT In rmation w	, listed belo ternational hich is mat	w and, insofar as the su application in the mar erial to patentability a	ed States application(s), ubject matter of each of the large provided by the first seeined in 37 CFR § 1.5 lling date of this applicat	ne claims of this appl paragraph of 35 U.S 6 which became ava	ication is not di S.C. § 112. Lack	sclosed in the
(Application Number)			(Filing Date) (S		(Status – patente	ed, pending, aba	ndoned)
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Reg. No. 23,063; Noi Reg. No. 24,861; Los No. 26,916; Joseph a Bernstein, Reg. No. Mack, Reg. No. 30,9 Daniels, Reg. No. 32 F. Neils, Reg. No. 3 application and to tabout the applicati Washington, D.C. 20 I hereby declare tha	pert V. Siduis Gubins J. Ruch, Jul 25,665; Al 25,665; Al 562, Brian 3,102, Br ransact al on be add 0037.	nan, Reg. No. ky, Reg. No. c., Reg. No. an J. Kaspe L. Bernstei n W. Hanno ett S. Sylve l business dressed to	D. 22,775; Peter D. Ole D. 24,835; Neil B. Siege 26,577; Sheldon I. Lar er, Reg. No. 25,426; Ker in, Reg. No. 31,484; Ma on, Reg. No. 32,778, Abi ester, Reg. No. 32,765 in the Patent and Trac SUGHRUE, MION, 2	peak, Reg. No. 19,292; Rxy, Reg. No. 24,513; J. Fr. I., Reg. No. 25,200; David dsman, Reg. No. 25,430; neeth J. Burchfiel, Reg. No. 32,19 raham J. Rosner, Reg. No. and Robert M. Masters, demark Office connected ZINN, MACPEAK & SEVILLE ST. SEVILLE	rank Osha, Reg. No. J. Cushing, Reg. N. J. Cushing, Reg. N. Richard C. Turner, No. 31,333; Gordon F. William H. Mand. 33,276; Bruce E. K. Reg. No. 35,603; my therewith, and requests, PLLC, 2100 P.	24,625; Wadde o. 28,703; John Reg. No. 29,71 (it, Reg. No. 30, itr, Reg. No. 32, ramer, Reg. No. 4 attorneys to puest that all corennsylvania Aven information.	Il A. Biggart, R. Inge, Reg. D; Howard L. 764; Susan J. 156; Scott M. 33,725; Paul rosecute this respondence venue, N.W.,
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Date Februar	y 19,	1999	First Inventor	Takafumi	Ata	rashi	
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